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REPLY UNDER 37 C.F.R § 1.116 EXPEDITED PROCEDURE EXAMINING GROUP 1765

DEC 1 9 2005

PATENT 5298-06900/PM01027

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Schwarz

Serial No. 10/074,888

Filed: February 13, 2002

For: REDUCI

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WITHIN AN ETCHED

SEMICONDUCTOR TOPOGRAPHY

Group Art Unit: 1765

Examiner: Duy Vu Nguyen Deo

Auy. Dkt. No. 5298-06900

I hereby certify that this correspondence is being deposited transmitted via facsimile or deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313, on the date indicated below:

12/19/2005

Date Parnela Ger

## RESPONSE AFTER FINAL REJECTION PURSUANT TO 37 CFR § 1.116

Box: Alf Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313

Dear Sir/Madam:

This paper is submitted in response to the final Office Action mailed October 19, 2005.

Remarks begin on page 2 of this paper.